ASSOCIATION CONNECTING	© Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved untions.	nder both	This docum level parts,	ent is a declara the declaration	ion of the s encompasse	ubstances es all lowe	within the manufactu r level materials for w	rer listed i which the r	tem. Note: i nanufacturer	f the item is an as has engineering	ssembly with lower responsibility.	
1752-21.1					Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Inform	ation														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi											2025-05-13				
Contact Name			Title - Contact				Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester	quester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	Pate Version Manufacturing Site			Weight*	UOM	Unit Type		
		FODM611R2		SO5 10MB T&R			2025-05-13		1	LITEONFG		97.594	mg	Each	
Manufacturing I	Proccess Information	1						-							
Terminal Plating / Grid Array Material T			erminal Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperatu		ure Max Time at Peak Temper		ture Numb	er of Reflow Cy	cles			
Matte Tin (Sn) - annealed CU A			CU Alloy	Alloy 1			260 C 30		30	seconds 3					
Comments															
evel 1 - maximum ti	me at peak temperature o	luring sol	dering is 10-3	0 seconds											
or more informatio	n regarding material con	position	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth					
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	8.8	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		3.96	mg
			Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.88	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		3.96	mg
Die	0.237	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.077	mg
			Supplier	Silicon (Si)	7440-21-3		0.16	mg
Die Attach	0.009	mg	Supplier	Silver (Ag)	7440-22-4		0.007	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.002	mg
Lead Frame	17.018	mg	Supplier	Silver (Ag)	7440-22-4		0.0017	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0204	mg
			Supplier	Iron (Fe)	7439-89-6		0.3914	mg
			Supplier	Copper (Cu)	7440-50-8		16.5994	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0051	mg
Mold Compound-Black	70.32	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4- hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		2.81	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		16.2	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.11	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		49.2	mg
Plating	1.16	mg	Supplier	Tin (Sn)	7440-31-5		1.16	mg
Wire Bond - Au	0.05	mg	Supplier	Gold (Au)	7440-57-5		0.05	mg